

Attorney Docket No.: 01-234

PATENT

**DECLARATION, POWER OF ATTORNEY, AND PETITION**

As a below named inventor, I hereby declare that:

My residence, post office address, and citizenship are as stated below next to my name.

I believe I am the original, first, and sole inventor (if only one name is listed below) or an original, first, and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled "ALIGNMENT PROCESS FOR INTEGRATED CIRCUIT STRUCTURES ON SEMICONDUCTOR SUBSTRATE USING SCATTEROMETRY MEASUREMENTS OF LATENT IMAGES IN SPACED APART TEST FIELDS ON SUBSTRATE", the specification of which:

  X   is attached hereto.  
       was filed on \_\_\_\_\_ as Application Serial No. \_\_\_\_\_, and was amended on \_\_\_\_\_.  
(if applicable)

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, § 1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

PRIOR FOREIGN APPLICATION(S)			Priority Claimed
(Number)	(Country)	(Date Filed)	Yes ____ No ____
(Number)	(Country)	(Date Filed)	Yes ____ No ____
(Number)	(Country)	(Date Filed)	Yes ____ No ____

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, § 1.56(a), regarding events which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Application Serial No.)	(Filing Date)	(Status)
(Application Serial No.)	(Filing Date)	(Status)

I hereby declare that all statements made of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

I hereby appoint John P. Taylor, Reg. 22,369; Sandeep Jaggi, Reg. 43,331; Timothy R. Croll, Reg. 36,771; Leo J. Peters, Reg. 33,562; Pete R. Scott, Reg. 33,279; and John Chen, Reg. 39,136; as my attorneys with full power of substitution and revocation, to prosecute this application and to transact all business in the U.S. Patent and Trademark Office connected therewith and before competent international authorities.

Please send all correspondence to:

Sandeep Jaggi, Chief IP Counsel  
Intellectual Property Law Department  
LSI Logic Corporation  
M/S D-106  
1551 McCarthy Boulevard  
Milpitas, CA 95035  
(408) 954-4923

Wherefore I pray that Letters Patent be granted to me for the invention or discovery described and claimed in the foregoing specification and claims, and I hereby subscribe my name to the foregoing specification and claims, declaration, power of attorney, and this petition.

First Inventor's Full Name: Colin D. Yates  
(First) (Initial) (Last)

Inventor's Signature: 

Date: 11-26-2001 Country of Citizenship: United Kingdom

Residence Address: San Jose, California

Post Office Address: 5977 Arabian Court, San Jose, CA 95123 USA

Second Inventor's Full Name: Nicholas F. Pasch  
(First) (Initial) (Last)

Inventor's Signature: \_\_\_\_\_

Date: \_\_\_\_\_ Country of Citizenship: U.S.A.

Residence Address: Pacifica, California

Post Office Address: 1470 De Solo Drive, Pacifica, CA 94044 USA

Third Inventor's Full Name: Nicholas K. Eib  
(First) (Initial) (Last)

Inventor's Signature: 

Date: 11/26/2001 Country of Citizenship: U.S.A.

Residence Address: San Jose, California

Post Office Address: 781 Almondwood Way, San Jose, CA 95120 USA

Fourth Inventor's Full Name: \_\_\_\_\_  
(First) (Initial) (Last)

Inventor's Signature: \_\_\_\_\_

Date: \_\_\_\_\_ Country of Citizenship: \_\_\_\_\_

Residence Address: \_\_\_\_\_

Post Office Address: \_\_\_\_\_

## PATENT

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			Yes ___ No ___
(Number)	(Country)	(Date Filed)	
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Please send all correspondence to:

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Intellectual Property Law Department  
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First Inventor's Full Name: Colin D. Yates  
(First) (Initial) (Last)

Inventor's Signature: \_\_\_\_\_

Date: \_\_\_\_\_ Country of Citizenship: United Kingdom

Residence Address: San Jose, California

Post Office Address: 5977 Arabian Court, San Jose, CA 95123 USA

Second Inventor's Full Name: Nicholas F. Pasch  
(First) (Initial) (Last)

Inventor's Signature: Nicholas F. Pasch

Date: Nov 26, 2001 Country of Citizenship: U.S.A.

Residence Address: Pacifica, California

Post Office Address: 1470 De Soto Drive, Pacifica, CA 94044 USA

Third Inventor's Full Name: Nicholas K. Eib  
(First) (Initial) (Last)

Inventor's Signature: \_\_\_\_\_

Date: \_\_\_\_\_ Country of Citizenship: U.S.A.

Residence Address: San Jose, California

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Fourth Inventor's Full Name: \_\_\_\_\_  
(First) (Initial) (Last)

Inventor's Signature: \_\_\_\_\_

Date: \_\_\_\_\_ Country of Citizenship: \_\_\_\_\_

Residence Address: \_\_\_\_\_

Post Office Address: \_\_\_\_\_